

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	15	"printing electrical connection"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:38
S2	8	"3D printing" and "molten metal" and electrical	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:43
S3	1110	347/50	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:43
S4	103220	"molten metal"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:43
S5	0	S3 and S4	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:43
S6	552	S3 and metal	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:43
S7	438	S6 and electrical	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:43
S8	394	S7 and connection	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:43
S9	11	S8 and 3d	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:45
S10	2076	"inorganic semiconductor" and "3D printing"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:46
S11	0	"inorganic semiconductor" and "3D printing"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:46

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S12	2076	"inorganic semiconductor"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:46
S13	112	"Direct Metal Deposition"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:48
S14	183191	S13 3D	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:48
S15	8	S13 and 3D	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:58
S16	256	"3D printing"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:58
S17	162781	S16 and solder droplets	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:59
S18	0	S16 and "solder droplets"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:59
S19	228	"solder droplets"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 13:59
S20	85	S19 and printing	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 14:00
S21	21	"object incorporation device"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 14:02
S22	1659820	"drop in" semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 14:03
S23	61	"drop in" and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/08 14:04

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S24	8	S16 and solder	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/09 07:29
S25	2	"20040161715"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/09 07:59